

	Type	L #	Hits	Search Text	DBs	Time Stamp	Error Count	Definition	Errors
1	BRS	L1	219	(wafer or semiconductor) with (dry\$3 or dried) with kep\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/12 18:07			0
2	BRS	L2	248	(wafer or semiconductor) with (dry\$3 or dried) with keep\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/12 18:08			0
3	BRS	L3	118	2 with (etch\$3 or clean\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/12 18:08			0
4	BRS	L4	51	3 and @pd<=19990618	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/12 18:09			0